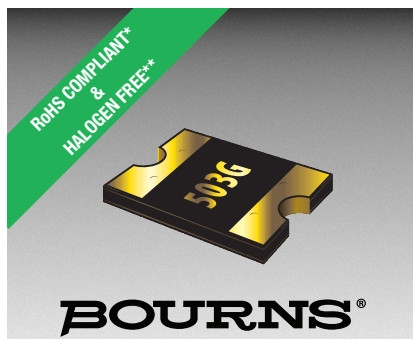




Features

- Very low profile
- Very fast tripping time
- High voltage
- RoHS compliant* and halogen free**
- 2018 footprint
- Agency recognition:  



Some models are currently available but not recommended for new designs.

MF-SMDF Series – PTC Resettable Fuses

Electrical Characteristics



Model	V _{max}	I _{max}	I _{hold}	I _{trip}	Resistance		Max. Time To Trip		Tripped Power Dissipation	Agency Recognition	
					at 23 °C		at 23 °C	at 23 °C		cUL	TÜV
	Volts	Amps	Amps	Amps	R _{min}	R _{1max}	Amps	Seconds	Watts at 23 °C		
MF-SMDF030	60	20	0.30	0.8	0.45	2.15	1.5	1.2	0.8	✓	
MF-SMDF050	60	10	0.55	1.2	0.20	1.00	2.5	3.0	0.9	✓	✓
MF-SMDF100/33X	33	40	1.1	2.2	0.06	0.40	8.0	0.5	1.4	✓	
MF-SMDF150	15	40	1.5	3.0	0.05	0.17	8.0	0.8	1.1	✓	✓
MF-SMDF200	10	40	2.0	4.0	0.03	0.10	8.0	2.4	1.1		
MF-SMDF260/24X	24	20	2.6	5.2	0.015	0.075	8.0	5.0	1.5	✓	✓

Environmental Characteristics

Item		Condition	Criteria
Operating Temperature		-40 °C to +85 °C	
Recommended Storage		+40 °C max. / 70 % R.H. max.	
Passive Aging		+85 °C, 1000 hours	±5 % typical resistance change
Humidity Aging	MF-SMDF030, 050, 150, 200	+85 °C, 85 % R.H. 1000 hours	±1.2 % typical resistance change
	MF-SMDF100/33X, 260/24X		±5 % typical resistance change
Thermal Shock	MF-SMDF030, 050, 150, 200	-40 °C to +85 °C, 20 times	-20 % typical resistance change
	MF-SMDF100/33X, 260/24X		±10 % typical resistance change
Solvent Resistance		MIL-STD-202, Method 215	No change (marking still legible)
Vibration		MIL-STD-883C, Method 2007.1 Condition A	No change (R _{min} < R < R _{1max})
Moisture Sensitivity Level (MSL)		See Note	
ESD Classification		Class 6 (per AEC-Q200-2, HBM)	

Test Procedures and Requirements

Item	Test Conditions	Accept/Reject Criteria
Visual/Mechanical	Verify dimensions and materials	Per MF physical description
Resistance	In still air @ 23 °C	R _{min} ≤ R ≤ R _{1max}
Time to Trip	At specified current, V _{max} , 23 °C, still air	T ≤ max. time to trip (seconds)
Hold Current	30 min. at I _{hold} , still air	No trip
Trip Cycle Life	V _{max} , I _{max} , 100 cycles	No arcing or burning
Trip Endurance	V _{max} , 48 hours	No arcing or burning
Solderability	245 °C ±5 °C, 5 seconds	95 % min. coverage

Additional Information

Click these links for more information:



[PRODUCT SELECTOR](#)



[TECHNICAL LIBRARY](#)



[INVENTORY](#)



[SAMPLES](#)



[CONTACT](#)



CALIFORNIA WARNING: Can expose you to lead, a carcinogen and reproductive toxicant.

See www.P65Warnings.ca.gov

* RoHS Directive 2015/863, Mar 31, 2015 and Annex.

** Bourns considers a product to be "halogen free" if (a) the Bromine (Br) content is 900 ppm or less; (b) the Chlorine (Cl) content is 900 ppm or less; and (c) the total Bromine (Br) and Chlorine (Cl) content is 1500 ppm or less.

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Applications

- Power Over Ethernet (IEEE 802.3 af) port protection
- Automotive electronic control module protection
- Telecom equipment low voltage protection

MF-SMDF Series – PTC Resettable Fuses

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Thermal Derating Table - I_{hold} (Amps)

Model	Ambient Operating Temperature								
	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C
MF-SMDF030	0.50	0.43	0.37	0.30	0.25	0.22	0.18	0.15	0.11
MF-SMDF050	0.87	0.77	0.67	0.55	0.46	0.41	0.36	0.31	0.23
MF-SMDF100/33X	1.66	1.47	1.29	1.10	0.91	0.83	0.73	0.64	0.50
MF-SMDF150	2.38	2.10	1.82	1.50	1.27	1.13	0.99	0.85	0.64
MF-SMDF200	2.95	2.65	2.35	2.00	1.74	1.59	1.44	1.29	1.06
MF-SMDF260/24X	3.75	3.35	3.00	2.60	2.35	2.15	2.05	1.80	1.50

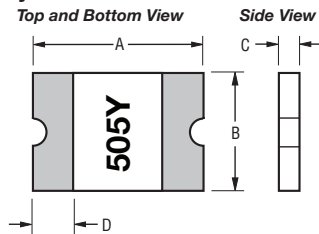
I_{trip} is approximately two times I_{hold} .

Product Dimensions

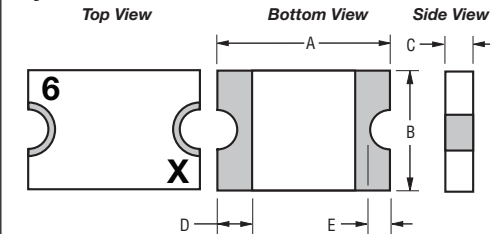
Model	A		B		C		D	E		Style
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.	Max.	
MF-SMDF030	4.72 (0.186)	5.44 (0.214)	4.22 (0.166)	4.93 (0.194)	0.79 (0.031)	1.09 (0.043)	0.30 (0.012)	N/A	N/A	1
MF-SMDF050	4.72 (0.186)	5.44 (0.214)	4.22 (0.166)	4.93 (0.194)	0.79 (0.031)	1.09 (0.043)	0.30 (0.012)	N/A	N/A	1
MF-SMDF100/33X	4.72 (0.186)	5.44 (0.214)	4.22 (0.166)	4.93 (0.194)	0.70 (0.028)	1.25 (0.049)	0.30 (0.012)	0.25 (0.010)	0.70 (0.028)	2
MF-SMDF150	4.72 (0.186)	5.44 (0.214)	4.22 (0.166)	4.93 (0.194)	0.55 (0.022)	0.85 (0.033)	0.30 (0.012)	N/A	N/A	1
MF-SMDF200	4.72 (0.186)	5.44 (0.214)	4.22 (0.166)	4.93 (0.194)	0.55 (0.022)	0.85 (0.033)	0.30 (0.012)	N/A	N/A	1
MF-SMDF260/24X	4.72 (0.186)	5.44 (0.214)	4.22 (0.166)	4.93 (0.194)	0.70 (0.028)	2.00 (0.079)	0.30 (0.012)	0.25 (0.010)	0.70 (0.028)	3

DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$

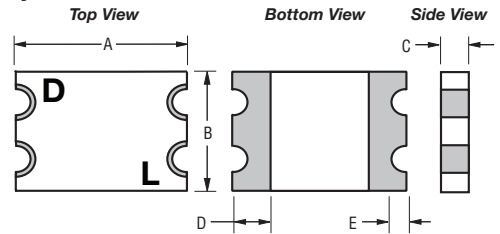
Style 1



Style 2



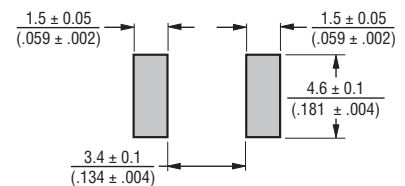
Style 3



Terminal material:

Electroless Ni under immersion Au

Recommended Pad Layout



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MF-SMDF Series – PTC Resettable Fuses

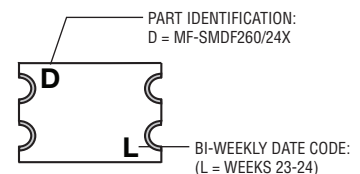
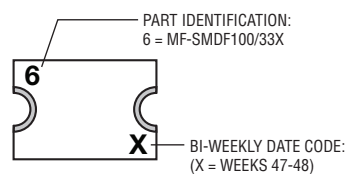
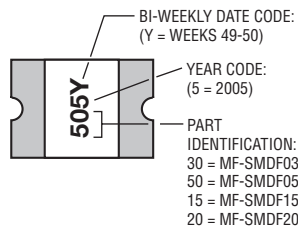
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Packaging Quantity

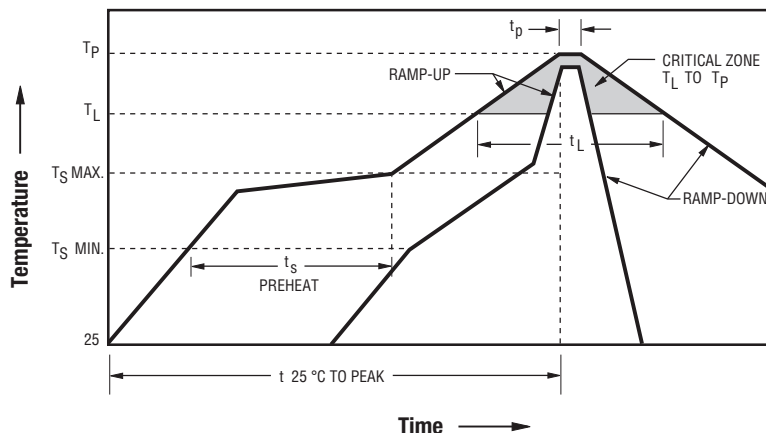
Model	Unit Quantity (pcs.)	Unit
MF-SMDF030 MF-SMDF050	6000	Reel
MF-SMDF100/33X MF-SMDF150		
MF-SMDF200		
MF-SMDF260/24X	4000	Reel

Typical Part Marking

Represents total content. Layout may vary.



Solder Reflow Recommendations



Notes:

- MF-SMDF models are intended for reflow soldering (including but not limited to heating plate, hot air, IR, nitrogen, and vapor phase).
- Wave soldering is permissible only if the device is on the top of the PCB, opposite the heat source.
- Hand soldering is not recommended for these devices.
- All temperatures refer to the topside of the device, measured on the device body surface.
- If reflow temperatures exceed the recommended profile, devices may not meet the published specifications.
- Compatible with Pb and Pb-free solder reflow profiles.
- Excess solder may cause a short circuit.
- Please refer to the [Multifuse® Polymer PTC Resettable Fuse Soldering Recommendations](#) document for more details.

Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate (T _S max to T _p)	3 °C / second max.
PREHEAT:	
Temperature Min. (T _S min)	150 °C
Temperature Max. (T _S max)	200 °C
Time (T _S min to T _S max) (t _s)	60~180 seconds
TIME MAINTAINED ABOVE:	
Temperature (T _L)	217 °C
Time (t _L)	60~150 seconds
Peak Temperature (T _p)	260 °C
Time within 5 °C of Actual Peak Temperature (t _p)	20~40 seconds
Ramp-Down Rate	6 °C / second max.
Time 25 °C to Peak Temperature	8 minutes max.

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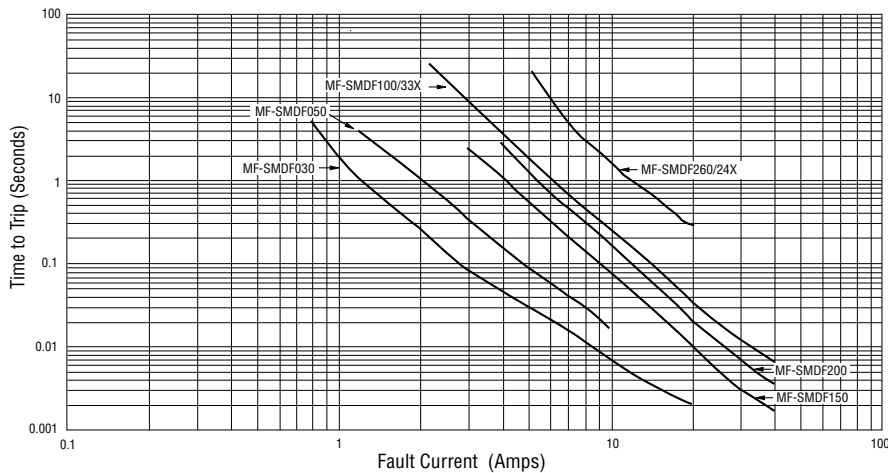
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MF-SMDF Series – PTC Resettable Fuses

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Typical Time to Trip at 23 °C



The Time to Trip curves represent typical performance of a device in a simulated application environment. Actual performance in specific customer applications may differ from these values due to the influence of other variables.

How to Order

MF - SMDF 100 /33X - 2

Product Designator _____
 Series _____
 SMDF = 2018 Surface Mount Component
 Hold Current, I_{hold} _____
 030 = 0.30 A
 050 = 0.50 A
 100 = 1.10 A
 150 = 1.50 A
 200 = 2.00 A
 260 = 2.60 A
 Higher Voltage Option _____
 _____ = Standard Voltage
 /24X = 24 V Rated
 /33X = 33 V Rated
 X = Multifuse® freeXpansion Design™
 MF-SMDF Series
 Packaging _____
 -2 = Tape and Reel Packaged per EIA-481

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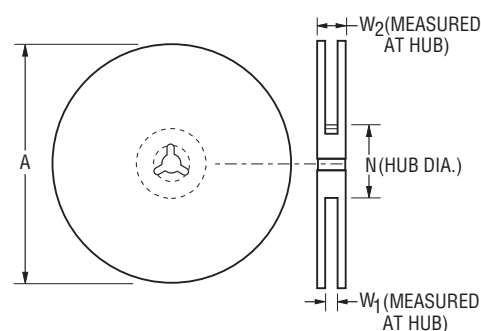
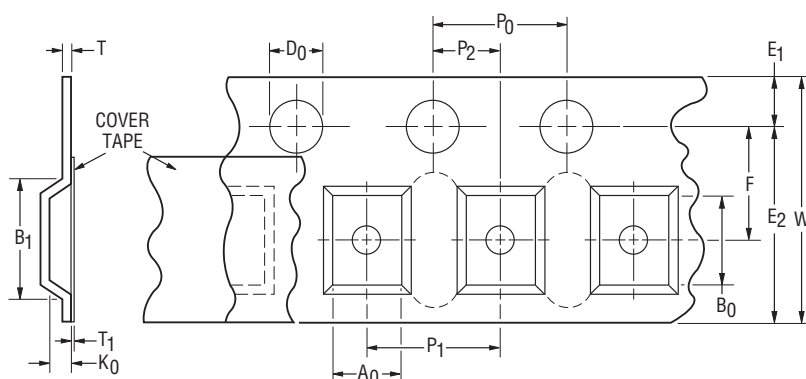
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MF-SMDF Series Tape and Reel Specifications

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Tape Dimensions per EIA 481	MF-SMDF030, 050, 150, 200	MF-SMDF100/33X	MF-SMDF260/24X
W	16.0 ± 0.3 (0.630 $\pm$ 0.012)	16.0 ± 0.3 (0.630 $\pm$ 0.012)	16.0 ± 0.3 (0.630 $\pm$ 0.012)
P ₀	4.0 ± 0.1 (0.157 $\pm$ 0.004)	4.0 ± 0.1 (0.157 $\pm$ 0.004)	4.0 ± 0.1 (0.157 $\pm$ 0.004)
10P ₀	40 ± 0.2 (1.575 $\pm$ 0.008)	40 ± 0.2 (1.575 $\pm$ 0.008)	40 ± 0.2 (1.575 $\pm$ 0.008)
P ₁	8.0 ± 0.1 (0.315 $\pm$ 0.004)	8.0 ± 0.1 (0.315 $\pm$ 0.004)	8.0 ± 0.1 (0.315 $\pm$ 0.004)
P ₂	2.0 ± 0.1 (0.079 $\pm$ 0.004)	2.0 ± 0.1 (0.079 $\pm$ 0.004)	2.0 ± 0.1 (0.079 $\pm$ 0.004)
A ₀	5.1 ± 0.15 (0.201 $\pm$ 0.006)	5.1 ± 0.15 (0.201 $\pm$ 0.006)	5.4 ± 0.15 (0.213 $\pm$ 0.006)
B ₀	5.6 ± 0.15 (0.220 $\pm$ 0.006)	5.6 ± 0.15 (0.221 $\pm$ 0.006)	5.7 ± 0.15 (0.234 $\pm$ 0.006)
B ₁ max.	12.1 (0.476)	12.1 (0.476)	12.1 (0.476)
D ₀	$1.5 + 0.1/-0.0$ (0.059 + 0.004/-0)	$1.5 + 0.1/-0.0$ (0.059 + 0.004/-0)	$1.5 + 0.1/-0.0$ (0.059 + 0.004/-0)
F	7.5 ± 0.10 (0.295 + 0.004)	7.5 ± 0.10 (0.295 + 0.004)	7.5 ± 0.10 (0.295 + 0.004)
E ₁	1.75 ± 0.10 (0.069 $\pm$ 0.004)	1.75 ± 0.10 (0.069 $\pm$ 0.004)	1.75 ± 0.10 (0.069 $\pm$ 0.004)
E ₂ min.	14.25 (0.561)	14.25 (0.561)	14.25 (0.561)
T max.	0.6 (0.024)	0.6 (0.024)	0.6 (0.024)
T ₁ max.	0.1 (0.004)	0.1 (0.004)	0.1 (0.004)
K ₀	1.1 ± 0.15 (0.043 $\pm$ 0.006)	1.1 ± 0.15 (0.043 $\pm$ 0.006)	2.15 ± 0.15 (0.085 $\pm$ 0.006)
Leader min.	390 (15.35)	390 (15.35)	390 (15.35)
Trailer min.	160 (6.30)	160 (6.30)	160 (6.30)
Reel Dimensions			
A max.	331 (13.03)	331 (13.03)	331 (13.03)
N min.	50 (1.97)	50 (1.97)	50 (1.97)
W ₁	$16.4 + 2.0/-0.0$ (0.646 + 0.079/-0)	$16.4 + 2.0/-0.0$ (0.646 + 0.079/-0)	$16.4 + 2.0/-0.0$ (0.646 + 0.079/-0)
W ₂ max.	22.4 (0.882)	22.4 (0.882)	22.4 (0.882)

DIMENSIONS: $\frac{\text{MM}}{\text{(INCHES)}}$



MF-SMDF SERIES, REV. X, 04/26

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Application Notice

- Users are responsible for independent and adequate evaluation of Bourns® Multifuse® Polymer PTC devices in the user's application, including the PPTC device characteristics stated in the applicable data sheet.
- Polymer PTC devices must not be allowed to operate beyond their stated maximum ratings. Operation in excess of such maximum ratings could result in damage to the PTC device and possibly lead to electrical arcing and/or fire. Circuits with inductance may generate a voltage above the rated voltage of the polymer PTC device and should be thoroughly evaluated within the user's application during the PTC selection and qualification process.
- Polymer PTC devices are intended to protect against adverse effects of temporary overcurrent or overtemperature conditions up to rated limits and are not intended to serve as protective devices where overcurrent or overvoltage conditions are expected to be repetitive or prolonged.
- In normal operation, polymer PTC devices experience thermal expansion under fault conditions. Thus, a polymer PTC device must be protected against mechanical stress, and must be given adequate clearance within the user's application to accommodate such thermal expansion. Rigid potting materials or fixed housings or coverings that do not provide adequate clearance should be thoroughly examined and tested by the user, as they may result in the malfunction of polymer PTC devices if the thermal expansion is inhibited.
- Exposure to lubricants, silicon-based oils, solvents, gels, electrolytes, acids, and other related or similar materials may adversely affect the performance of polymer PTC devices.
- Aggressive solvents may adversely affect the performance of polymer PTC devices. Conformal coating, encapsulating, potting, molding, and sealing materials may contain aggressive solvents including but not limited to xylene and toluene, which are known to cause adverse effects on the performance of polymer PTCs. Such aggressive solvents must be thoroughly cured or baked to ensure their complete removal from polymer PTCs to minimize the possible adverse effect on the device.
- Recommended storage conditions should be followed at all times. Such conditions can be found on the applicable data sheet and on the Multifuse® Polymer PTC Moisture/Reflow Sensitivity Classification (MSL) note:
https://www.bourns.com/docs/RoHS-MSL/msl_mf.pdf

MFAN 12/18

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The characteristics and parameters of a Bourns® product set forth in its data sheet are based on laboratory conditions, and statements regarding the suitability of products for certain "typical" applications are based on Bourns' knowledge of typical requirements in generic applications. Bourns assumes that "typical" applications include failsafe/backup features to address critical risks to users and are designed to allow rework of Bourns® product to avoid scrap of a device solely due to malfunctioning Bourns® product. The characteristics and parameters of a Bourns® product in a user application may vary from the data sheet characteristics and parameters due to (i) the combination of the Bourns® product with other components in the user's application, or (ii) the environment of the user application itself. The characteristics and parameters of a Bourns® product also can and do vary in different applications and actual performance may vary over time. Thus, users should always verify the actual performance of the Bourns® product in their specific devices and applications and make their own independent judgments regarding the suitability of Bourns® product and the amount of additional test margin to design into their device or application to compensate for differences between laboratory and real-world conditions.

Unless Bourns has explicitly designated an individual Bourns® product as meeting the requirements of a particular industry standard (e.g., IATF 16949) or a particular qualification (e.g., UL listed or recognized), Bourns is not responsible for any failure of an individual Bourns® product to meet the requirements of such industry standard or particular qualification even if such industry standard or qualification is a "state of art". Users of Bourns® products are responsible for ensuring compliance with safety-related requirements and standards applicable to their devices or applications.

Bourns® products are not recommended, authorized or intended for use in applications where failure or malfunction may result in personal injury, death, or severe property or environmental damage, such as without limitation nuclear, life-critical medical and certain automotive and aviation applications. Except as set forth in the bullet points below or unless expressly and specifically approved in writing on a case-by-case basis by an authorized Bourns' representative, use of any Bourns® products in such unauthorized high-risk applications is at the user's sole risk.

- Bourns considers implantable/invasive devices and devices/procedures designed as life-supporting or life-sustaining by the U.S. Food and Drug Administration or equivalent organizations outside of the United States as "life-critical" medical applications. Bourns expressly identifies those Bourns® standard products that are suitable for use in typical medical applications that are not life-critical in its publication entitled "Bourns Medical Grade Component Guide."
- Bourns expressly identifies those Bourns® standard products that are suitable for use in typical automotive applications associated with any Automate Safety Integrity Level (ASIL) in its publication entitled "Bourns Automotive Grade Component Guide." Bourns' designation of Bourns® product as compliant with the AEC-Q standard does not by itself mean that Bourns has approved such product for use in an automotive application.
- Bourns expressly identifies Bourns® standard products that are suitable for use in the typical aviation applications/systems requiring System Design Assurance Level (RTCA DO-254 DAL) of C, D or E in its publication entitled "Bourns Civilian Aerospace/Aviation Grade Component Guide." Bourns does not test its products for compliance with United States Federal Aviation Administration standards or any other generally equivalent governmental organization standard applicable to products designed or manufactured for use in aviation applications. Use of Bourns® standard components in aviation applications associated with RTCA DO-254 DAL A or B without proper approval noted above shall be at the user's sole risk.
- Bourns will review and authorize on a case-by-case basis the use of Bourns® standard products which are at least AEC-Q compliant in space-related civil applications (rockets, satellites) with a negotiated cross-waiver and indemnity agreement.

The use and level of testing applicable to Bourns® custom products shall be negotiated on a case-by-case basis by Bourns and the user for which such Bourns® custom products are specially designed. Absent a written agreement between Bourns and the user regarding the use and level of such testing, the above provisions applicable to Bourns® standard products shall also apply to such Bourns® custom products.

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